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Application Serial No	ا الدر
Application Serial No	7/26/
Filing Date January 10, 2000	1- 91
Inventor Rickie C. Lake	,
Assignee Micron Technology, Inc.	
Group Art Unit	
Examiner J. Haran	
Attorney's Docket No MI40-274	
Title: "Method of Conductively Interconnecting Electronic Components, Battery Powerable Apparatus, Radio Frequency Communication Device, and Electric Circuit"	

## RESPONSE TO DECEMBER 19, 2001 OFFICE ACTION

To:

**Assistant Commissioner for Patents** 

Washington, D.C. 20231

EV077328676

From:

James D. Shaurette (Tel. 509-624-4276; Fax 509-838-3424)

Wells, St. John, P.S.

601 W. First Avenue, Suite 1300 Spokane, WA 99201-3828

Sir:

Responsive to the Office Action dated December 19, 2001, Applicant ame remarks as follows:

## <u>AMENDMENTS</u>

## In the Specification

Please replace the paragraph beginning at line 1 of page1 with the following clean replacement paragraph in accordance with 37 C.F.R. § 1.121(b)(1)(ii):

## --RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent Application Serial No. 09/022,812, filed February 12, 1998, entitled "Thin Profile Battery Bonding Method and Method of Conductively Interconnecting Electronic Components", naming Rickie C. Lake